

# ST4460FX

# High voltage fast-switching NPN Power transistor

# **General features**

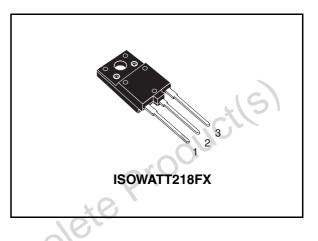
- High voltage and high current capability
- Low spread of dynamic parameters
- Low base-drive requirements
- Very high switching speed
- High ruggedness
- Fully insulated power package U.L. compliant

# Applications

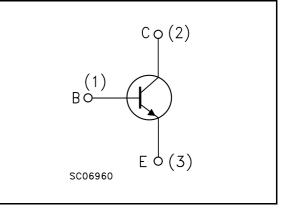
■ Switch mode power supplies for CRT TV

# Description

The device is manufactured using high voltage Multi Epitaxial Mesa technology adopting Hollow Emitter structure to enhance switching performances.



# Internal schematic diagram



## Order codes

Part Number	Marking	Package	Packing
ST4460FX	4460FX	ISOWATT218FX	Tube

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# **Electrical ratings**

Table 1. Absolute maximum rating	Table 1.	Absolute	maximum	rating
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Symbol	Parameter	Value	Unit
V <sub>CES</sub>	Collector-emitter voltage (V <sub>BE</sub> = 0)	1000	V
V <sub>CEO</sub>	Collector-emitter voltage ( $I_B = 0$ )	500	V
V <sub>EBO</sub>	Collector-base voltage $(I_{\rm C} = 0)$	9	V
Ι <sub>C</sub>	Collector current	15	А
I <sub>CM</sub>	Collector peak current (t <sub>P</sub> < 5ms)	30	А
۱ <sub>B</sub>	Base current	7 G	А
P <sub>TOT</sub>	Total dissipation at $T_c = 25^{\circ}C$	63	W
V <sub>isol</sub>	Insulation withstand voltage (RMS) from all three leads to external heatsink	2500	V
T <sub>stg</sub>	Storage temperature	-65 to 150	°C
Τ <sub>J</sub>	Max. operating junction temperature	150	0
Table 2.	Thermal data		

#### Table 2. Thermal data

Symbol Parameter		Value	Unit		
R <sub>thj-case</sub> Thermal resistance junction-case ma		max	2	°C/W	
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### **Electrical characteristics** 2

 $(T_{case} = 25^{\circ}C \text{ unless otherwise specified})$ 

Symbol	Parameter	Test Condit	ions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector cut-off current (V <sub>BE</sub> =0)	V <sub>CE</sub> = 1000V V <sub>CE</sub> = 1000V; 1	「 <sub>C</sub> = 125°C			100 500	μΑ μΑ
I <sub>CEO</sub>	Collector cut-off current (I <sub>B</sub> =0)	V <sub>CE</sub> = 500V				250	μA
V <sub>CEO(sus)</sub> <sup>(1)</sup>	Collector-emitter sustaining voltage (I <sub>B</sub> =0)	I <sub>C</sub> = 10mA		500	JU		v
V <sub>EBO</sub>	Emitter-base voltage (I <sub>c</sub> =0)	I <sub>E</sub> = 10mA	~	9			V
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage	$I_{C} = 6A$ $I_{C} = 8A$ $I_{C} = 10A$	$I_B = 1.2A$ $I_B = 1.6A$ $I_B = 2A$			1 1.5 3	V V V
V <sub>BE(sat)</sub> <sup>(1)</sup>	Base-emitter saturation voltage	$I_{\rm C} = 6A$ $I_{\rm C} = 8A$	I <sub>B</sub> = 1.2A I <sub>B</sub> = 1.6A			1.5 1.6	V V
h <sub>FE</sub> <sup>(1)</sup>	DC current gain	$I_{\rm C} = 1.2 \text{A}$ $I_{\rm C} = 6 \text{A}$	$V_{CE} = 5V$ $V_{CE} = 5V$	28 10		45	
t <sub>s</sub> t <sub>f</sub>	Inductive load Storage time Fall time	$V_{BE(off)} = -5V$ R	I <sub>B1 =</sub> 1.6A R <sub>BB</sub> = 0.4Ω L = 200μH		1.5 55	2.3 100	μs ns
t <sub>s</sub> t <sub>f</sub>	Inductive load Storage time Fall time	$V_{BE(off)} = -5V$ R	$I_{B1} = 1.6A$ $R_{BB} = 0.4\Omega$ $L = 200\mu$ H		1.9 80		μs ns

#### **Electrical characteristics** Table 3.

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#### **Electrical characteristics (curve)** 2.1

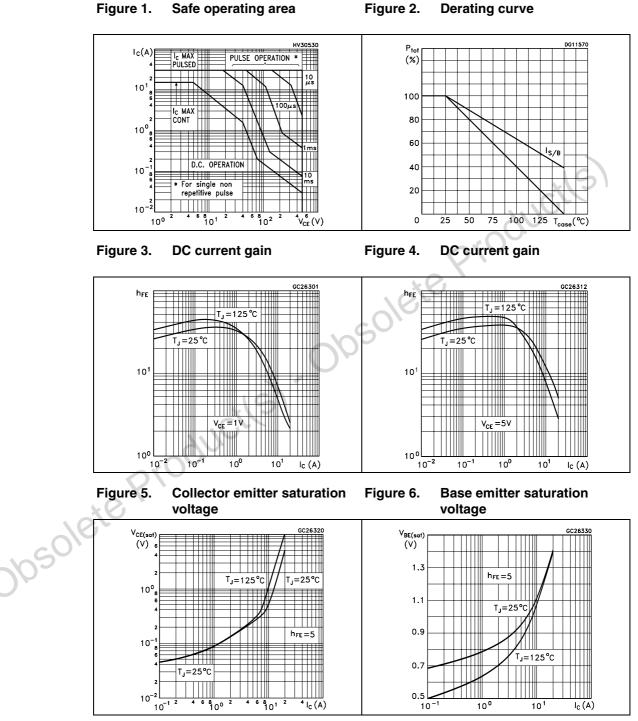


Figure 1. Safe operating area

GC26 360

 $V_{Clamp} = 350 V$   $h_{FE} = 5$   $V_{BEoff} = -5V$ 

T<sub>J</sub> =25 °C

10

12 I<sub>c</sub>(A)

57

 $R_{BB} = 0.4 \Omega$ 

#### Figure 7. Inductive fall time Figure 8. Inductive storage time

6 5

4

3

2

0

2

T<sub>J</sub> = 100 °C

4

6 8

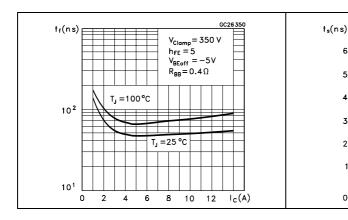
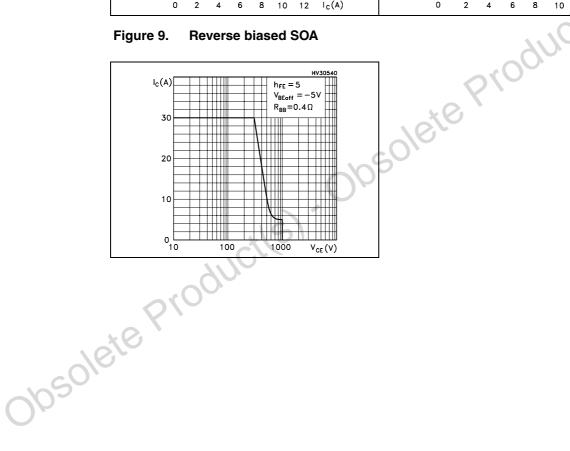
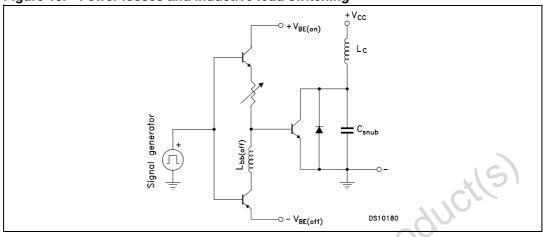


Figure 9. **Reverse biased SOA** 

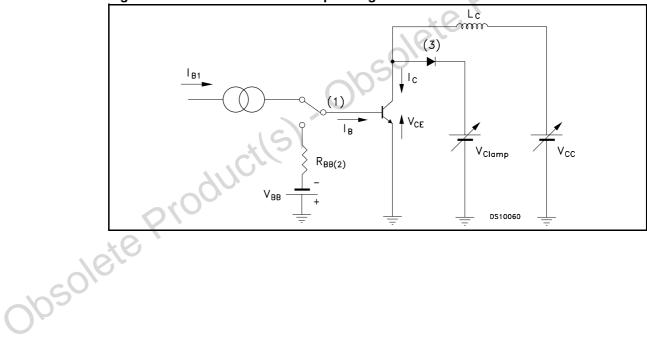


# 2.2 Test circuits



## Figure 10. Power losses and inductive load switching







# 3 Package mechanical data

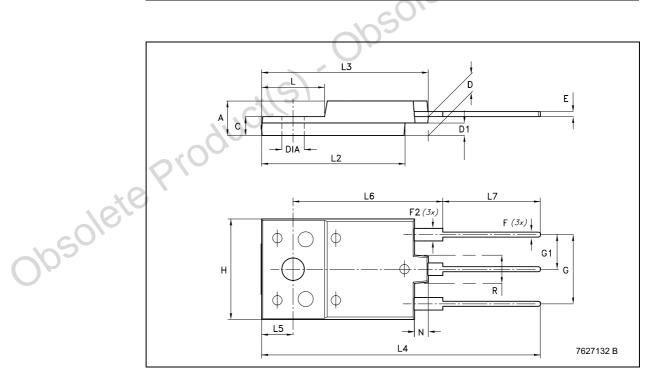
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Product(s). Obsolete Product(s)

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### ISOWATT218FX MECHANICAL DATA

DIM.	mm.					
DIM.	MIN.	ТҮР	MAX.			
A	5.30		5.70			
С	2.80		3.20			
D	3.10		3.50			
D1	1.80		2.20			
E	0.80		1.10			
F	0.65		0.95			
F2	1.80		2.20			
G	10.30		11.50			
G1		5.45				
Н	15.30		15.70			
L	9		10.20			
L2	22.80		23.20			
L3	26.30		26.70			
L4	43.20		44.40			
L5	4.30		4.70			
L6	24.30		24.70			
L7	14.60	- X	15			
N	1.80		2.20			
R	3.80		4.20			
Dia	3.40		3.80			





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# 4 Revision history

## Table 4. Revision history

Date	Revision	Changes
18-Dec-2006	1	Initial release.

obsolete Product(s). Obsolete Product(s)

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